

Low  $I_Q$ , Low Dropout 150mA Fixed Voltage Regulator

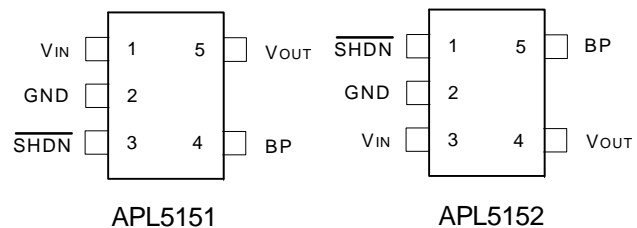
## Features

- Low Noise:  $60\mu V_{RMS}$  (100Hz to 100kHz)
- Low Quiescent Current: 50uA
- Low Dropout Voltage: 300mV  
( $V_{OUT}(\text{Nominal}) = 3.0V$  Version @150mA)
- Very low Shutdown Current: < 0.5uA
- Fixed Output Voltage: 1.3V, 1.4V, 1.5V, 1.6V, 1.7V, 1.8V, 1.9V, 2.0V, 2.1V, 2.2V, 2.3V, 2.4V, 2.5V, 2.6V, 2.7V, 2.8V, 2.85V, 2.9V, 3.0V, 3.1V, 3.2V, 3.3V, 3.4V, 3.5V, 4.75V, 4.8V, 4.9V, 5.0V
- Stable with 1uF Output Capacitor
- Stable with Aluminum, Tantalum or Ceramic Capacitors
- Reverse Current Protection
- No Protection Diodes Needed
- Built in Thermal Protection
- Built in Current Limit Protection
- Controlled Short Circuit Current: 50mA
- Fast transient Response
- Short Setting Time
- SOT-23-5 Package
- Lead Free Available (RoHS Compliant)

## General Description

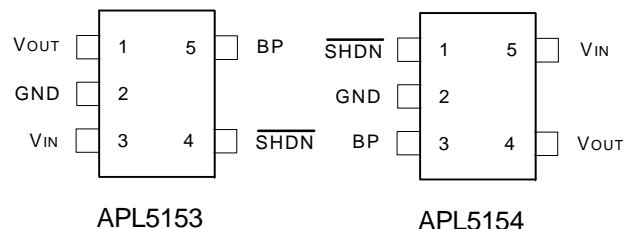
The APL5151/2/3/4 is micropower, low noise, low dropout linear regulator. Operate from 3V to 6V input voltage and deliver up to 150mA. Typical output noise is just  $60\mu V_{RMS}$  with the addition of an external 0.33uF bypass capacitor in BP pin and typical dropout voltage is only 220mV at 150mA loading. Designed for use in battery-powered system, the low 50uA quiescent current makes it an ideal choice. Design with an internal P-channel MOSFET pass transistor, the APL5151/2/3/4 maintains a low supply current, independent of the load current and dropout voltage. Other features include reverse current protection, thermal-shutdown protection, current limit protection to ensure specified output current and controlled short-circuit current. The APL5151/2/3/4 regulators come in a miniature SOT-23-5 package.

## Pin Configuration



## Applications

- Notebook Computer
- PDA or Portable Equipments
- Noise-Sensitive Instrumentation Systems



ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.



## Pin Description

PIN		I/O	Description
No.	Name		
1	V <sub>IN</sub>	I	Supply voltage input.
2	GND		Ground pins of the circuitry, and all ground pins must be soldered to PCB with proper power dissipation.
3	$\overline{\text{SHDN}}$	I	Shutdown control pin, low = off , high = normal.
4	BP	O	Bypass signal pin in fixed output type device
5	V <sub>OUT</sub>	O	Output pin of the regulator.

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
V <sub>IN</sub> , V <sub>OUT</sub>	Input Voltage or Out Voltage	6	V
$\overline{\text{SHDN}}$	Shutdown Control Pin	6	V
R <sub>TH,JA</sub>	Thermal Resistance – Junction to Ambient	260	°C/W
R <sub>TH,JC</sub>	Thermal Resistance – Junction to Case	130	°C/W
P <sub>D</sub>	Power Dissipation	Internally Limited	W
T <sub>J</sub>	Operating Junction Temperature		°C
	Control Section	0 to 125	
	Power Transistor	0 to 150	
T <sub>STG</sub>	Storage Temperature Range	-65 to +150	°C
T <sub>L</sub>	Lead Temperature (Soldering, 10 second)	260	°C

## Electrical Characteristics

Unless otherwise noted these specifications apply over full temperature , V<sub>IN</sub>=3.6V, C<sub>IN</sub>=C<sub>OUT</sub>=1uF,  $\overline{\text{SHDN}}$ =V<sub>IN</sub>, T<sub>J</sub>=0 to 125°C . Typical values refer to T<sub>J</sub>=25°C .

Symbol	Parameter	Test Conditions	APL5151/2/3/4			Unit
			Min.	Typ.	Max.	
V <sub>IN</sub>	Input Voltage		2.7		6	V
V <sub>OUT</sub>	Output Voltage	V <sub>OUT</sub> +1.0V < V <sub>CC</sub> <6.0V, 0mA < I <sub>OUT</sub> < I <sub>MAX</sub>	V <sub>OUT</sub> -2%	V <sub>OUT</sub>	V <sub>OUT</sub> +2%	V
I <sub>LIMIT</sub>	Circuit Current Limit	V <sub>IN</sub> =V <sub>OUT</sub> +1V	250	300	350	mA
I <sub>SHORT</sub>	Short Current	V <sub>OUT</sub> =0V	40	50	60	mA
I <sub>OUT</sub>	Load Current		150			mA
REG <sub>LINE</sub>	Line Regulation	V <sub>OUT</sub> +0.5V < V <sub>CC</sub> <6.0V, 0mA < I <sub>OUT</sub> < I <sub>MAX</sub>		4	10	mV
REG <sub>LOAD</sub>	Load Regulation	V <sub>IN</sub> =V <sub>OUT</sub> +1.0V, 0mA < I <sub>OUT</sub> < I <sub>MAX</sub>		1	6	mV
	Load Transient	V <sub>IN</sub> =V <sub>OUT</sub> +1V , I <sub>OUT</sub> =1mA-150mA in 1μs		70	150	mV

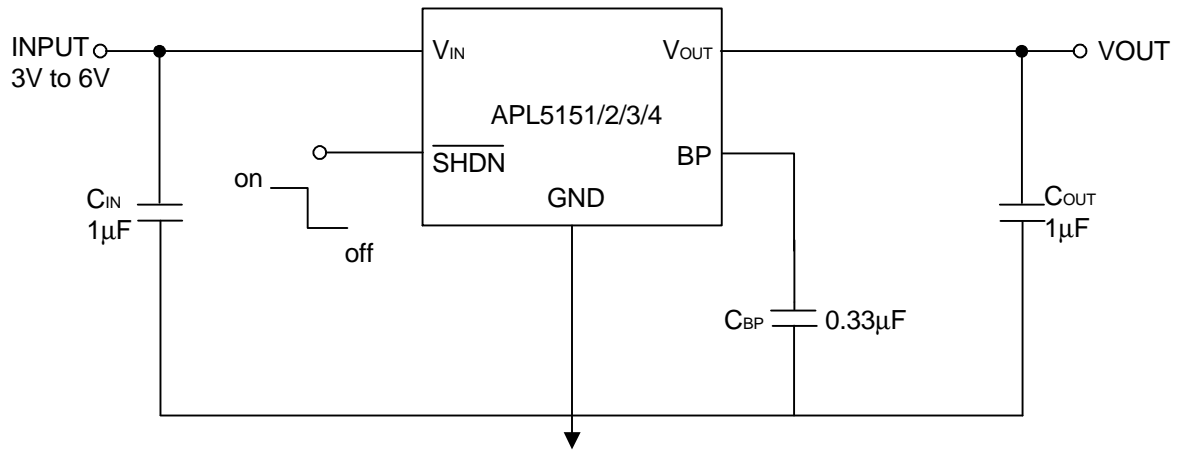
## Electrical Characteristics (Cont.)

Unless otherwise noted these specifications apply over full temperature,  $V_{IN}=3.6V$ ,  $C_{IN}=C_{OUT}=1\mu F$ ,  $\overline{SHDN}=V_{IN}$ ,  $T_J=0$  to  $125^\circ C$ . Typical values refer to  $T_J=25^\circ C$ .

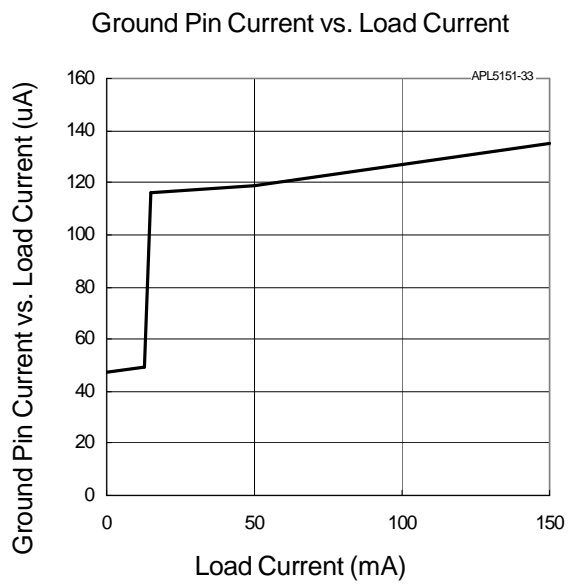
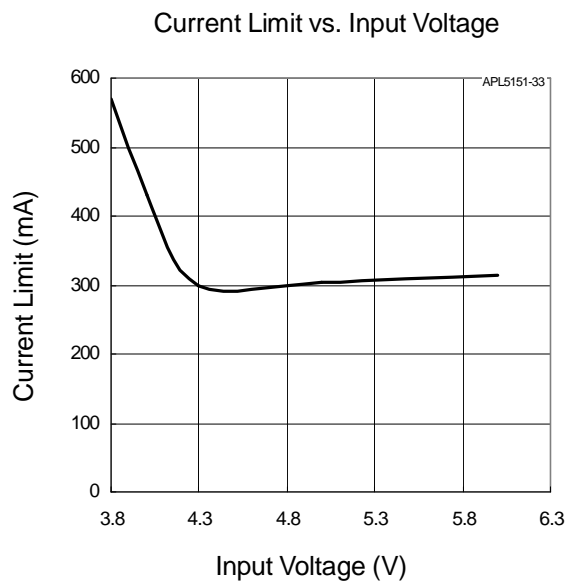
Symbol	Parameter	Test Conditions	APL5151/2/3/4			Unit
			Min.	Typ.	Max.	
PSRR	Ripple Rejection	$F \leq 1kHz$ , 1Vpp at $V_{IN} = V_{OUT} + 1.0V$ $C_{BP} = 0.1\mu F$ , $C_{OUT} = 1\mu F$	45	55		dB
$V_{DROD}$	Dropout Voltage <sup>(Note)</sup>	$I_{OUT} = 150mA$	$1.3V \leq V_{OUT} < 1.5V$	1.2	1.4	V
			$1.5V \leq V_{OUT} < 2.0$	1	1.2	
			$2.0V \leq V_{OUT} < 2.5$	0.7	0.8	
			$2.5V \leq V_{OUT} < 3$	0.3	0.4	
			$3V \leq V_{OUT} \leq 5$	0.2	0.3	
$I_Q$	Quiescent Current	No load		50	80	$\mu A$
		$I_{OUT} = 150mA$		135	170	
	Shutdown Supply Current	Shutdown = low $I_{OUT} = 0$ , $V_{CC} = 6.0V$		0.01	1	$\mu A$
	Noise	$100Hz < f < 100kHz$ , typical load, $C_{BP} = 0.1\mu F$ , $C_{OUT} = 1\mu F$		80		$\mu V_{rms}$
		$100Hz < f < 100kHz$ , typical load, $C_{BP} = 0.33\mu F$ , $C_{OUT} = 1\mu F$		60		
	Shutdown Recovery Delay	$C_{BP} = 0.1\mu F$ , $C_{OUT} = 1\mu F$ , no load		4		ms
		$C_{BP} = 0.33\mu F$ , $C_{OUT} = 1\mu F$ , no load		13.2		
OTS	Over Temperature Shutdown			150		$^\circ C$
	Over Temperature Shutdown Hysteresis	Hysteresis		10		$^\circ C$
TC	Output Voltage Temperature Coefficient			50		ppm/ $^\circ C$
$C_{OUT}$	Output Capacitor		0.8	1.0	2.6	$\mu F$
	ESR		0.02	0.1	1	Ohm
	Shutdown Input Threshold	$V_{OUT} + 1.0V < V_{IN} < 6.0V$	0.4	1.6	2.5	V
$I_{\overline{SHDN}}$	Shutdown Input Bias Current	$V_{\overline{SHDN}} = V_{IN}$		0.01	100	nA
	Input Reverse Leakage Current	$V_{OUT} - V_{IN} = 0.1V$		0.1	0.5	$\mu A$
	Reverse Protection Threshold			11	50	mV

Note: Dropout voltage definition :  $V_{IN} - V_{OUT}$  when  $V_{OUT}$  is 2% below the value of  $V_{OUT}$  for  $V_{IN} = V_{OUT} + 0.5V$ .

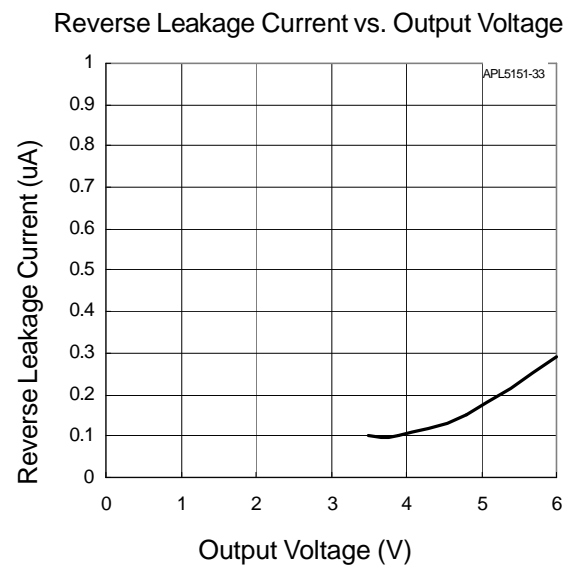
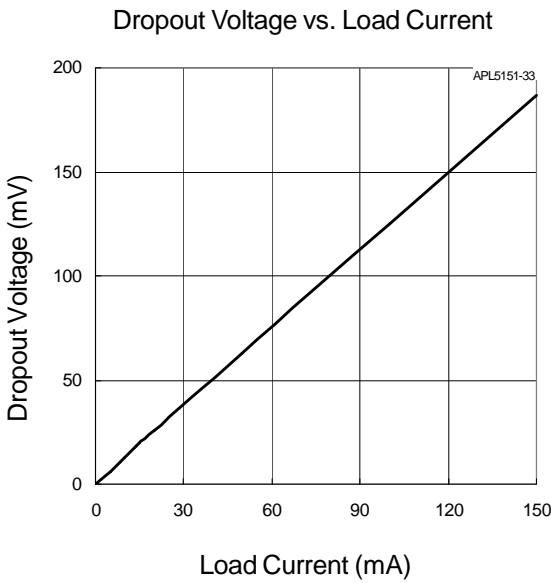
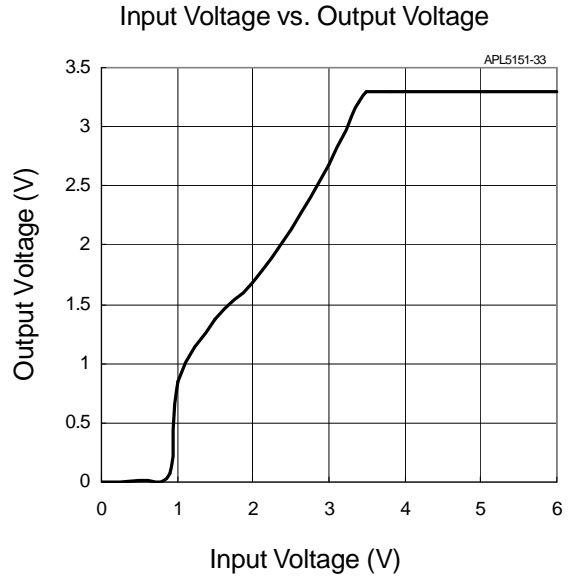
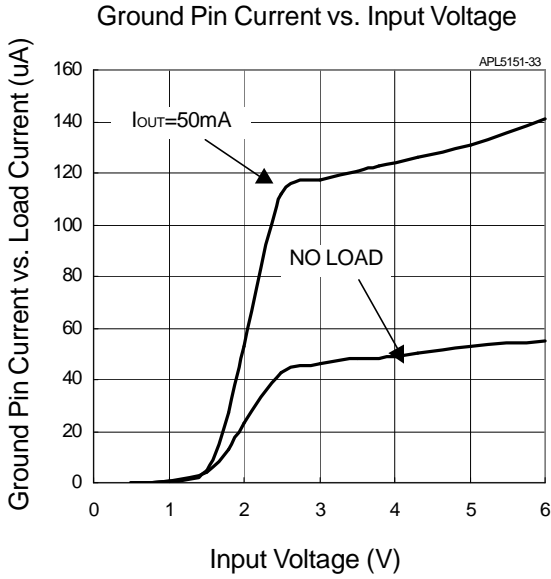
### Application Circuit



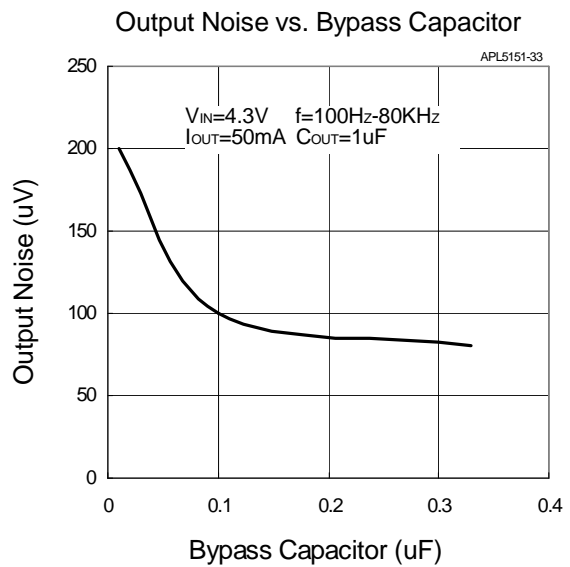
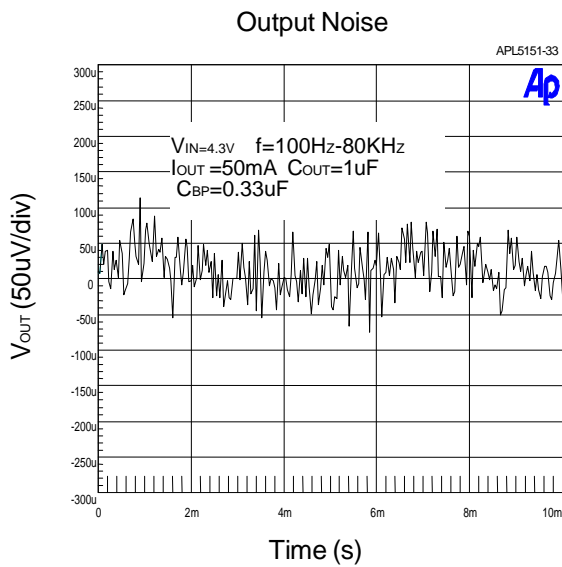
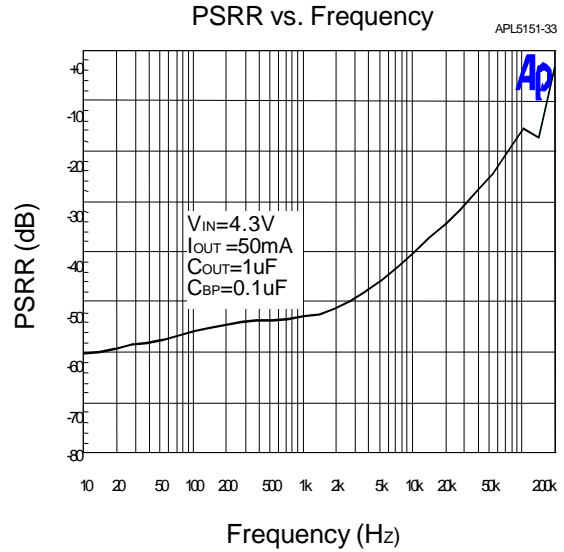
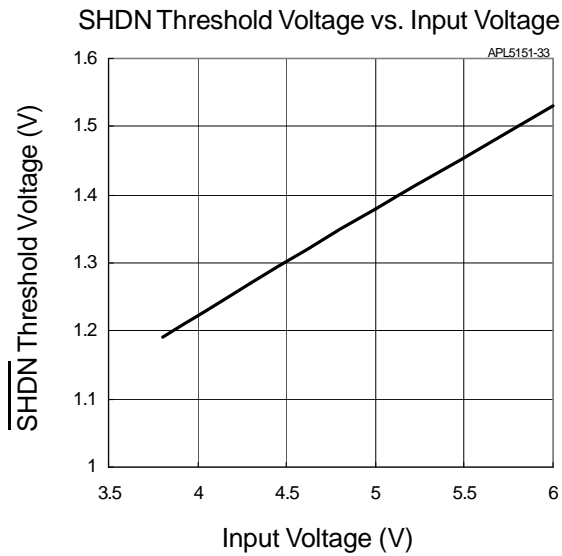
### Typical Characteristics



## Typical Characteristics

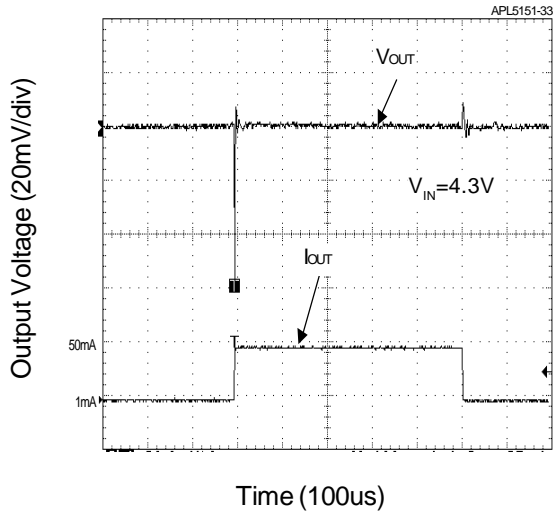


Typical Characteristics (Cont.)

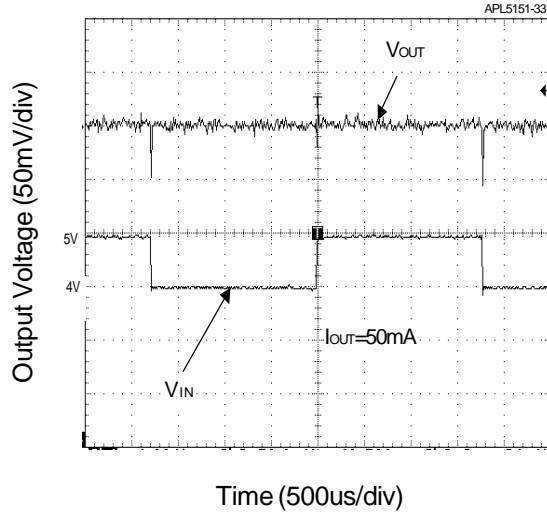


## Typical Characteristics (Cont.)

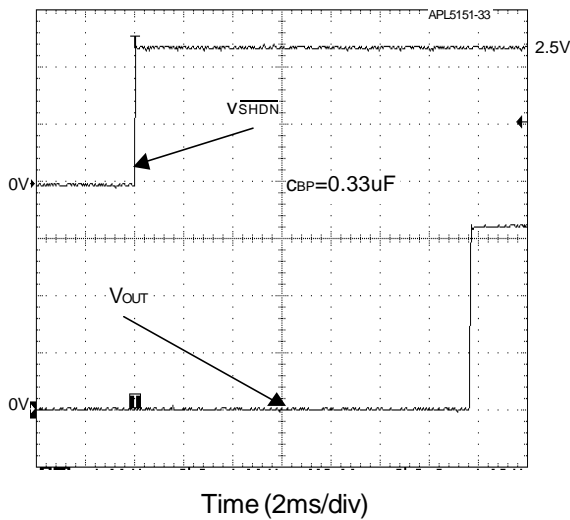
Load-Transient Response



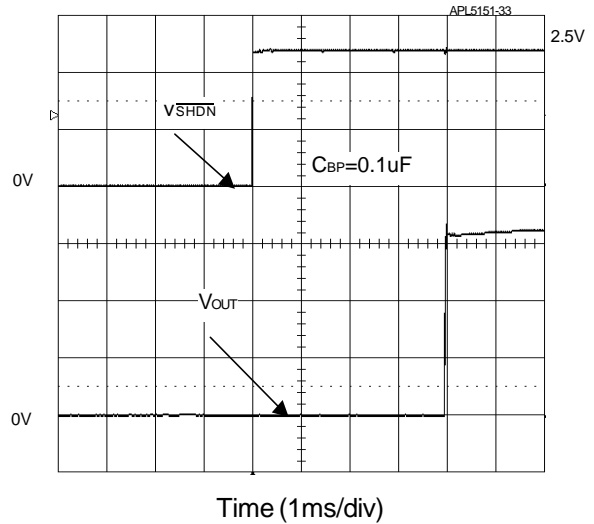
Line-Transient Response



Shutdown Exit Delay

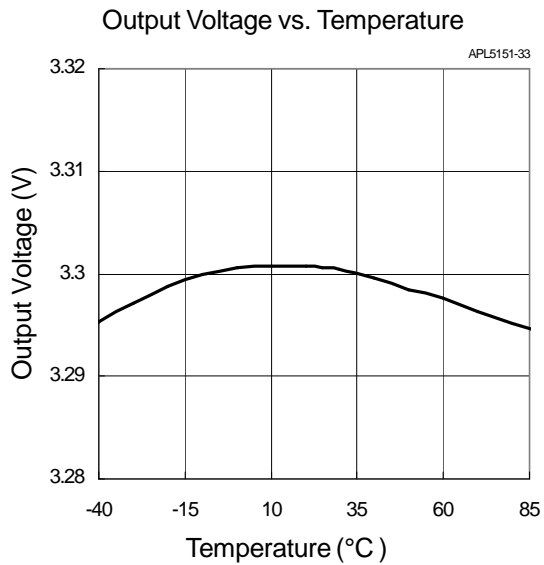
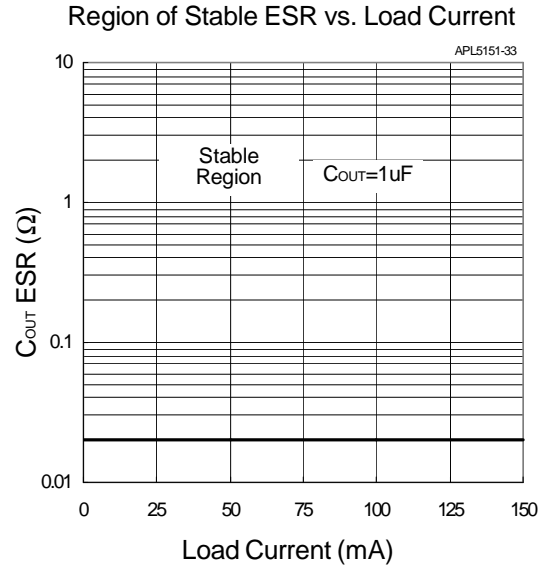
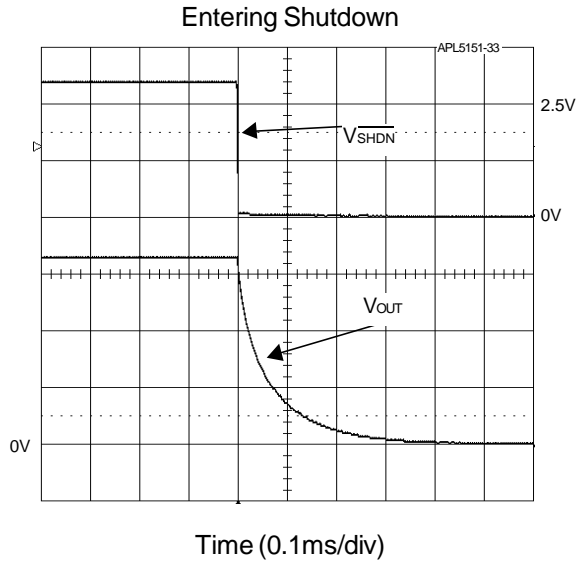


Shutdown Exit Delay





## Typical Characteristics (Cont.)



## Application Information

### Capacitor Selection and Regulator Stability

The APL5151/2/3/4 use at least a 1 $\mu$ F capacitor on the input, and this capacitor can be Aluminum, Tantalum or Ceramic capacitor. The input capacitor with larger value and lower ESR provides better PSRR and line-transient response. The output capacitor also can use Aluminum, Tantalum or Ceramic capacitor, and a minimum value of 1 $\mu$ F and ESR above 0.06 $\Omega$  is recommended. The curve of the stable region in typical characteristics shows the appropriate output capacitor ESR for different load current stable operation. A larger output capacitor can reduce noise and improve load-transient response, stability, and PSRR. Note that some ceramic dielectrics exhibit large capacitance and ESR variation with temperature. When using this capacitor, a minimum 2.2 $\mu$ F or more may be required to ensure the stability at low temperature operation. Use a bypass capacitor at BP pin for low output noise. Increasing the capacitance will slightly decrease the output noise, but increase the start-up time (See Shutdown Exit Delay and Output Noise vs. Bypass Capacitor graph in the typical characteristics).

### Load-Transient Considerations

The APL5151/2/3/4 load-transient response graphs in typical characteristics show the transient response. A step change in the load current from 1mA to 50mA at 1 $\mu$ s will cause a 60mV transient spike. Larger output capacitor and lower ESR can reduce transient spike.

### Input-Output (Dropout) Voltage

The minimum input-output voltage difference (dropout) determines the lowest usable supply voltage. In battery-powered systems, this will determine the useful end-of-life battery voltage. Because the APL5151/2/3/4 use a p-channel MOSFET pass transistor, the dropout voltage is a function of drain-

to-source on-resistance ( $R_{DS(ON)}$ ) multiplied by the load current.

### Reverse Current Protection

The APL5151/2/3/4 have an internal reverse protection, it does not need an external schottky diode to connect the regulator input and output. If the output voltage is forced above the input voltage by more than 11mV, the IC will be shutdown and the ground pin current is below 0.1 $\mu$ A.

### Current Limit

The APL5151/2/3/4 have a current limit protection. The output voltage will drop close to zero volt, when load current reaches the limit, and then the load current will be limited at 50mA after output voltage is below 0.7V. When the load current back to the value where limiting started, the output voltage and current will return to normal value. When output is shorted to ground, the APL5151/2/3/4 will keep short circuit current at 150mA.

### Thermal Protection

Thermal protection limits total power dissipation in the device. When the junction temperature exceeds  $T_j=+150^\circ\text{C}$ , the thermal sensor generates a logic signal to turn off the pass transistor and allows IC to cool. When the IC's junction temperature is down by 10 $^\circ\text{C}$ , the thermal sensor will turn the pass transistor on again, resulting in a pulsed output during continuous thermal protection. Thermal protection is designed to protect the APL5151/2/3/4 in the event of fault conditions. For continuous operation, do not exceed the absolute maximum junction temperature of  $T_j=+150^\circ\text{C}$ .

### Operating Region and Power Dissipation

The thermal resistance of the case to circuit board, and the rate of air flow all control the APL5151/2/3/4's

## Application Information (Cont.)

### Operating Region and Power Dissipation (Cont.)

maximum power dissipation. The power dissipation across the device is  $P_D = I_{OUT}(V_{IN} - V_{OUT})$  and the maximum power dissipation is:

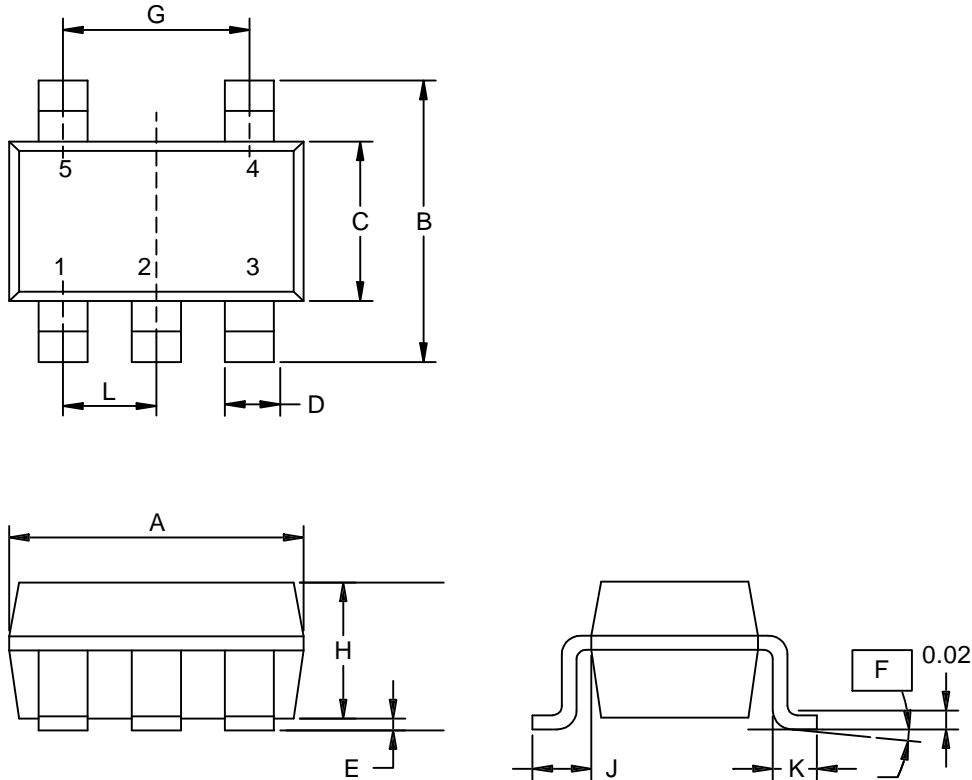
$$P_{D_{MAX}} = (T_J - T_A) / (\theta_{JC} + \theta_{CA})$$

where  $T_J - T_A$  is the temperature difference between the junction and ambient air,  $\theta_{JC}$  is the thermal resistance of the package, and  $\theta_{CA}$  is the thermal resistance through the printed circuit board, copper traces, and other materials to the ambient air.

The GND pin of the APL5151/2/3/4 provide an electrical connection to ground and channeling heat away. If power dissipation is large, connect the GND pin to ground using a large pad or ground plane, can improve the problem of over heat of IC.

## Packaging Information

SOT-23-5

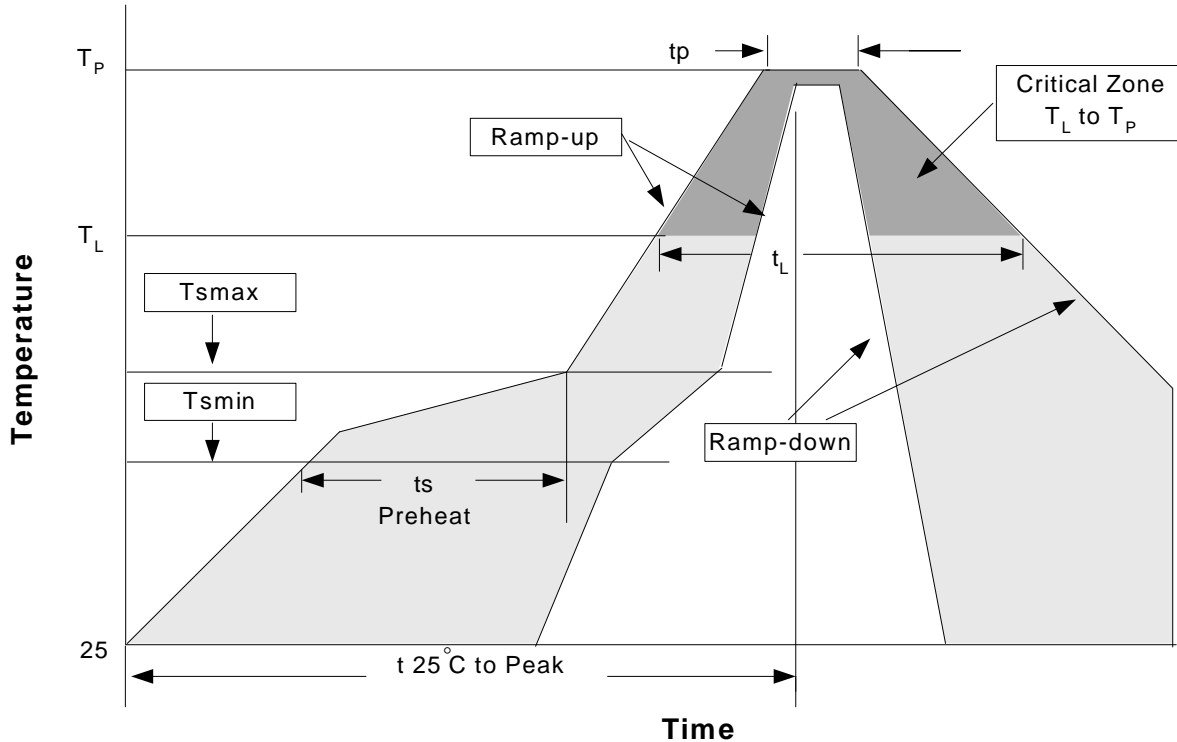


Dim	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.70	3.10	0.105	0.121
B	2.60	3.00	0.101	0.117
C	1.40	1.80	0.055	0.070
D	0.30	0.55	0.012	0.021
E	0	0.10	0	0.004
F	0°	10°	0°	10°
G	1.90 REF		0.074 REF	
H	1.20 REF		0.047 REF	
I	0.12 REF		0.005 REF	
J	0.37 REF		0.014 REF	
K	0.60 REF		0.023 REF	
L	0.95 REF		0.037 REF	

## Physical Specifications

Terminal Material	Solder-Plated Copper (Solder Material : 90/10 or 63/37 SnPb), 100%Sn
Lead Solderability	Meets EIA Specification RSI86-91, ANSI/J-STD-002 Category 3.

### Reflow Condition (IR/Convection or VPR Reflow)



### Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	3°C/second max.	3°C/second max.
Preheat		
- Temperature Min (T <sub>smin</sub> )	100°C	150°C
- Temperature Max (T <sub>smax</sub> )	150°C	200°C
- Time (min to max) (t <sub>s</sub> )	60-120 seconds	60-180 seconds
Time maintained above:		
- Temperature (T <sub>L</sub> )	183°C	217°C
- Time (t <sub>L</sub> )	60-150 seconds	60-150 seconds
Peak/Classification Temperature (T <sub>p</sub> )	See table 1	See table 2
Time within 5°C of actual Peak Temperature (t <sub>p</sub> )	10-30 seconds	20-40 seconds
Ramp-down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Notes: All temperatures refer to topside of the package .Measured on the body surface. (mm)

## Classification Reflow Profiles(Cont.)

Table 1. SnPb Eutectic Process – Package Peak Reflow Temperatures

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	240 +0/-5°C	225 +0/-5°C
≥2.5 mm	225 +0/-5°C	225 +0/-5°C

Table 2. Pb-free Process – Package Classification Reflow Temperatures

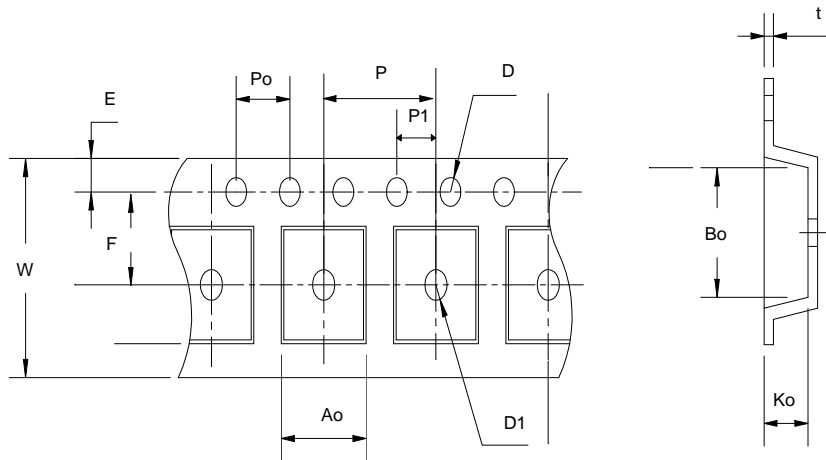
Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 +0°C*	260 +0°C*	260 +0°C*
1.6 mm – 2.5 mm	260 +0°C*	250 +0°C*	245 +0°C*
≥2.5 mm	250 +0°C*	245 +0°C*	245 +0°C*

\*Tolerance: The device manufacturer/supplier **shall** assure process compatibility up to and including the stated classification temperature (this means Peak reflow temperature +0°C. For example 260°C+0°C) at the rated MSL level.

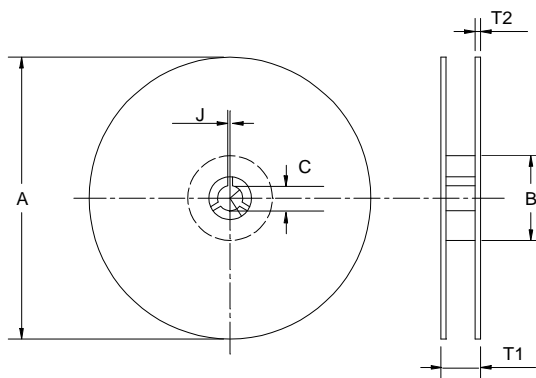
## Reliability Test Program

Test item	Method	Description
SOLDERABILITY	MIL-STD-883D-2003	245°C, 5 SEC
HOLT	MIL-STD-883D-1005.7	1000 Hrs Bias @125°C
PCT	JESD-22-B,A102	168 Hrs, 100%RH, 121°C
TST	MIL-STD-883D-1011.9	-65°C~150°C, 200 Cycles
ESD	MIL-STD-883D-3015.7	VHBM > 2KV, VMM > 200V
Latch-Up	JESD 78	10ms, 1 <sub>tr</sub> > 100mA

## Carrier Tape & Reel Dimensions



## Carrier Tape & Reel Dimensions(Cont.)



Application	A	B	C	J	T1	T2	W	P	E
SOT-23-5	178±1	72 ± 1.0	13.0 + 0.2	2.5 ± 0.15	8.4 ± 2	1.5± 0.3	8.0+ 0.3 - 0.3	4 ± 0.1	1.75± 0.1
	F	D	D1	Po	P1	Ao	Bo	Ko	t
	3.5 ± 0.05	1.5 + 0.1	1.5 + 0.1	4.0 ± 0.1	2.0 ± 0.1	3.15 ± 0.1	3.2± 0.1	1.4± 0.1	0.2±0.03

(mm)

## Cover Tape Dimensions

Application	Carrier Width	Cover Tape Width	Devices Per Reel
SOT-23	8	5.3	3000

## Customer Service

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